

Docket No. MAIKP131US

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re **PATENT** application of:

Applicant:

Teng-Wang Huang et al.

Application No.:

10/814,570

For:

PROCESS FOR ETCHING A SUBSTRATE

Filing Date:

March 31, 2004

Examiner:

Duy-Vu Nguyen Deo

Art Unit:

1765

SUBMISSION FILED IN CONJUNCTION WITH REQUEST FOR CONTINUED EXAMINATION

Mail Stop RCE Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir or Madam:

Favorable reconsideration of the above-identified application is respectfully requested in view of the following amendments and remarks.